

APPLICATION DATA SHEET**Inventor Information**

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Application Information

Title : METHODS AND APPARATUSES FOR PLANARIZING
MICROELECTRONIC SUBSTRATE ASSEMBLIES
Total Drawing Sheets : 4 (FOUR)
Formal Drawings : YES
Application Type : Utility
Attorney Docket Number : 500163.04
Assigned : Yes (Large Entity)

Representative Information

Representative Customer No. : 27,076

Continuity Information

This application is a : divisional of
>Application One : 09/356,808
Filing Date : July 20, 1999

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